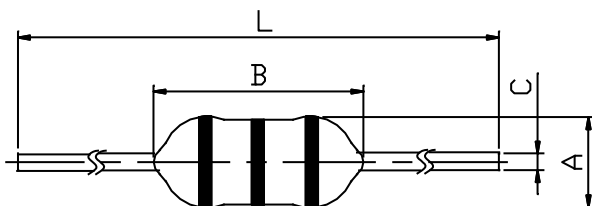


SPECIFICATION

TYPE	CESSNP
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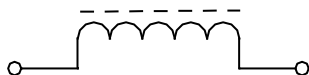
1. DIMENSION (UNIT: mm)



A	Max. $\phi 2.5$
B	Max. 3.4
C	$\phi 0.48 \pm 0.05$
L	61.0 ± 1.0

* THE LENGTH OF THE TERMINAL PINS DOES NOT INCLUDE SOLDER TIP.

2. CIRCUIT



3. MARKING

COLOR	FIRST FIGURE	SECOND FIGURE	MULTIPLIER
	1	2	3
BLACK	0	0	1
BROWN	1	1	10
RED	2	2	100
ORANGE	3	3	1000
YELLOW	4	4	-
GREEN	5	5	-
BLUE	6	6	-
VIOLET	7	7	-
GRAY	8	8	-
WHITE	9	9	-
GOLD	-	-	0.1
SILVER	-	-	0.01

30th, Sep., 2003			PART NO.	
APPROVAL	CHECK	DESIGN	Refer To P. 5/6, 6/6	
			REMARK	SPEC. No. 2/6
			LEAD FREE	H500-0188



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CESSNP

4. ELECTRICAL CHARACTERISTICS

No.	PART NO.	L (μ H)	L TOLERANCE	Qu Min.	D.C.R. (Ω) Max.	RATED CURRENT		S.R.F. (MHz) Min.	MEASURING FREQUENCY (MHz)	MATERIAL
						Max. (A)				
						Idc1	Idc2			
01	CESSNP-R10□	0.10	M、K	40	0.11	2.15	0.95	380	25.2	EM11
02	CESSNP-R12□	0.12			0.12	2.05	0.90	380		
03	CESSNP-R15□	0.15			0.13	1.95	0.82	380		
04	CESSNP-R18□	0.18			0.14	1.90	0.69	320		
05	CESSNP-R22□	0.22			0.16	1.85	0.65	290		
06	CESSNP-R27□	0.27			0.17	1.80	0.61	280		
07	CESSNP-R33□	0.33			0.18	1.75	0.60	270		
08	CESSNP-R39□	0.39			0.19	1.70	0.56	250		
09	CESSNP-R47□	0.47			0.20	1.60	0.52	230		
10	CESSNP-R56□	0.56			0.22	1.50	0.50	190		
11	CESSNP-R68□	0.68			0.25	1.44	0.47	170		
12	CESSNP-R82□	0.82			0.28	1.40	0.45	160		
13	CESSNP-1R0□	1.0	M、K、J	40	0.29	1.38	0.43	150	7.96	EM8B
14	CESSNP-1R2□	1.2			0.30	1.24	0.42	140		
15	CESSNP-1R5□	1.5			0.33	1.20	0.39	130		
16	CESSNP-1R8□	1.8			0.35	0.99	0.35	100		
17	CESSNP-2R2□	2.2			0.39	0.95	0.34	75		
18	CESSNP-2R7□	2.7			0.45	0.90	0.32	55		
19	CESSNP-3R3□	3.3			0.64	0.89	0.28	48		
20	CESSNP-3R9□	3.9			0.65	0.83	0.26	38		
21	CESSNP-4R7□	4.7		45	0.94	0.68	0.22	38		
22	CESSNP-5R6□	5.6			1.02	0.67	0.21	32		
23	CESSNP-6R8□	6.8			1.19	0.59	0.19	26		
24	CESSNP-8R2□	8.2			1.72	0.50	0.18	25		
25	CESSNP-100□	10			1.88	0.49	0.17	22		
26	CESSNP-120□	12		50	1.96	0.46	0.17	20	2.52	
27	CESSNP-150□	15			2.13	0.37	0.16	17		
28	CESSNP-180□	18			2.46	0.36	0.15	16		
29	CESSNP-220□	22			2.97	0.34	0.13	15		
30	CESSNP-270□	27			3.38	0.33	0.12	14		

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ELECTRICAL CHARACTERISTICS

No.	PART NO.	L (μ H)	L TOLERANCE	Qu Min.	D.C.R. (Ω) Max.	RATED CURRENT		S.R.F. (MHz) Min	MEASURING FREQUENCY (MHz)	MATERIAL
						Max. (A)				
						Idc1	Idc2			
31	CESSNP-330□	33	M、K、J	40	3.66	0.30	0.11	12	2.52	EM8B
32	CESSNP-390□	39			4.02	0.26	0.10	11		
33	CESSNP-470□	47			6.16	0.25	90m	9.0		
34	CESSNP-560□	56			7.04	0.23	85m	8.5		
35	CESSNP-680□	68			7.69	0.22	80m	8.0		
36	CESSNP-820□	82			8.68	0.21	70m	7.0		
37	CESSNP-101□	100			15.44	0.18	65m	6.0		
38	CESSNP-121□	120		25	17.63	0.17	60m	6.0	0.796	
39	CESSNP-151□	150			19.90	0.14	55m	5.0		
40	CESSNP-181□	180			20.89	0.13	50m	4.5		
41	CESSNP-221□	220			23.19	0.11	45m	4.5		
42	CESSNP-271□	270			26.88	0.10	40m	4.0		
43	CESSNP-331□	330			32.13	0.10	40m	4.0		

* □ : M: $\pm 20\%$, K: $\pm 10\%$, J: $\pm 5\%$

* TESTING INSTRUMENT

INDUCTANCE & Q: HP 4285A OR EQUIVALENT.

D.C.R.: HP 34420A OR EQUIVALENT.

RATED CURRENT: HP 4284A, HP42841A, HP E3632A, HP 34401A OR EQUIVALENT.

S.R.F. : HP 4395A HP4285A OR EQUIVALENT.

* Idc1: THE CURRENT WHEN THE INDUCTANCE DECREASES TO 90% OF INITIAL VALUE. (Ta=25°C)

* Idc2: THE CURRENT WHEN THE TEMPERATURE OF COIL IS INCREASED BY 20°C. (Ta=25°C)

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5. GENERAL CHARACTERISTICS

* STANDARD TESTING CONDITIONS:

UNLESS OTHERWISE SPECIFIED, THE STANDARD RANGE OF ATMOSPHERIC CONDITIONS FOR MEASUREMENTS AND TESTS ARE AS FOLLOWS: AMBIENT TEMPERATURE: 15°C~35°C. RELATIVE HUMIDITY : 25% ~85%. AIR PRESSURE : 86kPa ~106kPa.

IF THERE IS ANY DOUBT ABOUT THE RESULTS, MEASUREMENT SHALL BE MADE WITHIN THE FOLLOWING LIMITS: AMBIENT TEMPERATURE: 20°C±1°C RELATIVE HUMIDITY : 63% ~67%. AIR PRESSURE : 86kPa ~106kPa.

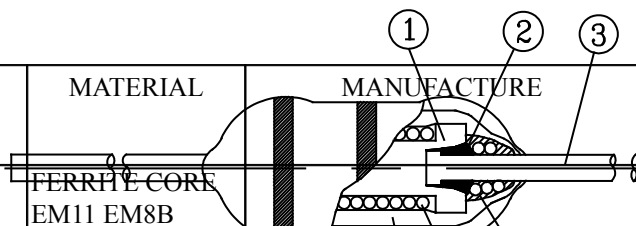
No.	ITEMS		TEST CONDITIONS	SPECIFICATION
1	OPERATION TEMPERATURE			-25 ~ +85°C (INCLUDING COIL TEMPERATURE RISE)
	STORAGE TEMPERATURE			-40 ~ +85°C
2	LEAD TERMINAL STRENGTH	PULLING	A STATIC PULLING FORCE OF 25N IN A DIRECTION PARALLEL TO THE LEAD TERMINALS FOR 5±1 SECONDS.	NO TERMINAL BREAKAGE OR LOOSENING.
		BENDING	LOAD WITH 3.0N AND 90° BENDING AND STRAIGHTENING TWICE IN TWO DIRECTIONS (UPWARD & DOWNWARD)	
3	DIELECTRIC WITHSTAND VOLTAGE TEST		D.C.500V APPLIED BETWEEN WINDING-BODY FOR 1 MINUTE.	NO DIELECTRIC DAMAGE
4	INSULATION RESISTANCE TEST		D.C.500V APPLIED BETWEEN WINDING-BODY FOR 1 MINUTE.	OVER 100 MΩ
5	OVER CURRENT TEST		INPUT 2 TIMES OF RATED INTO THE SAMPLE FOR 5 MINUTES.	NO FIRE OR ANY ABNORMALITY
6	RESISTANCE TO SOLDERING HEAT TEST		FIX THE SAMPLES ON A 1.6mm THICKNESS PCB, THEN DIP THE SAMPLE LEADS INTO A SOLDERING BATH OF 260±5°CUP TO THE PCB FOR 5±1 SECONDS.	NO MECHANICAL BREAKAGE. DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±3.0% Qu: WITHIN ±20%
7	SOLDER ABILITY TEST		IMMERSE THE TERMINAL IN FLUX FOR 5 SECONDS. THEN DIP THE TERMINAL INTO A SOLDERING BATH OF 235±5°C FOR 2±0.5 SECONDS.	OVER 90% OF THE SURFACE BEING IMMERSED SHALL BE COVERED WITH NEW SOLDER UNIFORMLY.
8	VIBRATION TEST		AMPLITUDE: 1.5mm P _z -P FREQUENCY:10~55~10Hz (1 MINUTE PER CYCLE) DURATION: 2 HOURS IN EACH OF X,Y,Z AXIS. (TOTAL 6 HOURS)	DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±1.0% Qu: WITHIN ±20%
9	SHOCK TEST		PEAK ACCELERATION: 981m/s ² DURATION OF PULSE: 10ms	DEVIATION RELATIVE TO INITIAL VALUE:

		SHOCK TIMES: 3 TIMES IN EACH OF X, Y, Z AXIS. (TOTAL 9 TIMES)	L: WITHIN ±1.0% Qu: WITHIN ±20%						
10	HUMIDITY TEST	TEMPERATURE: 40°C±2°C HUMIDITY: 90%~95%RH DURATION: 500±12 HOURS.	DEVIATION RELATIVE TO INITIAL VALUE: L: WITHIN ±10% Qu: WITHIN ±20%						
11	DRY HEAT TEST	TEMPERATURE: 85°C±2°C DURATION: 500±12 HOURS.							
12	COLD TEST	TEMPERATURE: -25°C±3°C DURATION: 500±12 HOURS.							
13	DRY HEAT WITH LOAD	TEMPERATURE: 85°C±2°C LOAD CONDITION: RATED CURRENT DURATION: 500±12 HOURS.							
14	DAMP HEAT WITH LOAD	TEMPERATURE: 40°C±2°C HUMIDITY: 90%~95%RH LOAD CONDITION: RATED CURRENT DURATION: 500±12 HOURS.							
15	THERMAL SHOCK	5 CONTINUOUS CYCLES SHOWN AS BELOW <table><tr><td>TEMPERATURE</td><td>DURATION</td></tr><tr><td>-25°C±3°C</td><td>30 MINUTES</td></tr><tr><td>85°C±2°C</td><td>30 MINUTES</td></tr></table>		TEMPERATURE	DURATION	-25°C±3°C	30 MINUTES	85°C±2°C	30 MINUTES
TEMPERATURE	DURATION								
-25°C±3°C	30 MINUTES								
85°C±2°C	30 MINUTES								

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6. CONSTRUCTION

No.	PARTS	MATERIAL	MANUFACTURE	COUNTRY OF ORIGIN	UL No.	TEMP CLASS
①	CORE	FERRITE CORE EM11 EM8B OR EQUIVALENT		CHINA	NA	NA
②	ADHESIVE	EPOXY RESIN	GUANG ZHOU WELLS CHEMICAL CO., LTD.	CHINA	NA	NA
③	LEAD WIRE	SOLDER PLATED COPPER WIRE	WELL FORE SPECIAL WIRE CORPORATION	CHINA	NA	NA
④	SOLDER	Sn-Cu-Ni	NIHON SUPERIOR., LTD. SHENGMAO CO., LTD.	JAPAN CHINA	NA NA	NA NA
⑤	WIRE	POLYURETHAN E ENAMELLED COPPER WIRE	JUNG SHING WIRE CO., LTD. PACIFIC-THAI ELECTRIC WIRE & CABLE CO.,LTD.	CHINA THAILAND	E174837 E142108	B B
⑥	UNDER-COATING RESIN	BUTADIENE RESIN	HOMETOWN INDUSTRIAL CO., LTD.	CHINA (TAIWAN)	NA	NA
⑦	OVER-COATING RESIN	EPOXY RESIN	HOMETOWN INDUSTRIAL CO., LTD.	CHINA (TAIWAN)	NA	NA
⑧	COLOR CODE	MELAMINE RESIN	HOMETOWN INDUSTRIAL CO., LTD.	CHINA (TAIWAN)	NA	NA

7. PACKING

PACKAGE TO BE ACCORDING TO PACKAGE SPECIFICATION (TICK THE RELEVANT “ ”)✓

- ☐ KB-PAT155
- ☐ KB-PAT156
- ☐ SPECIAL FOR CUSTOMER KB_____.

8. REMARK

THE WARNING FOR LEAD WIRE FORMING TO BE ACCORDING TO STD-003.

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